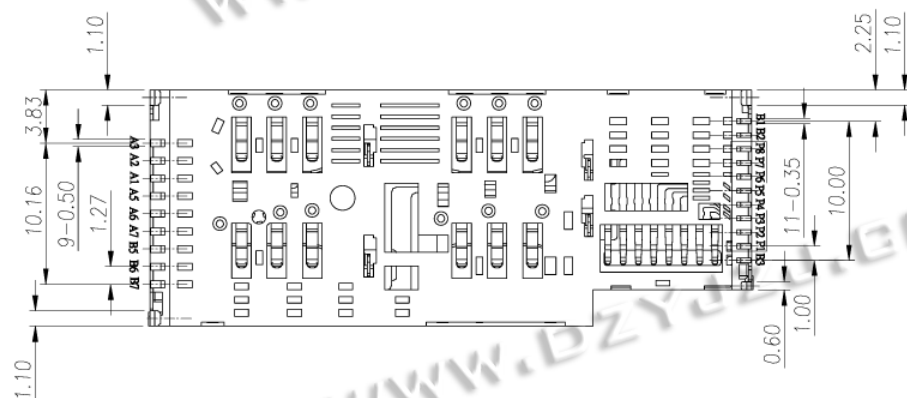
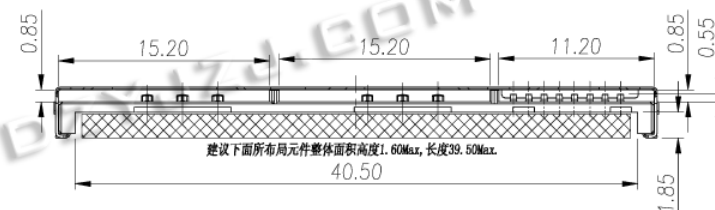
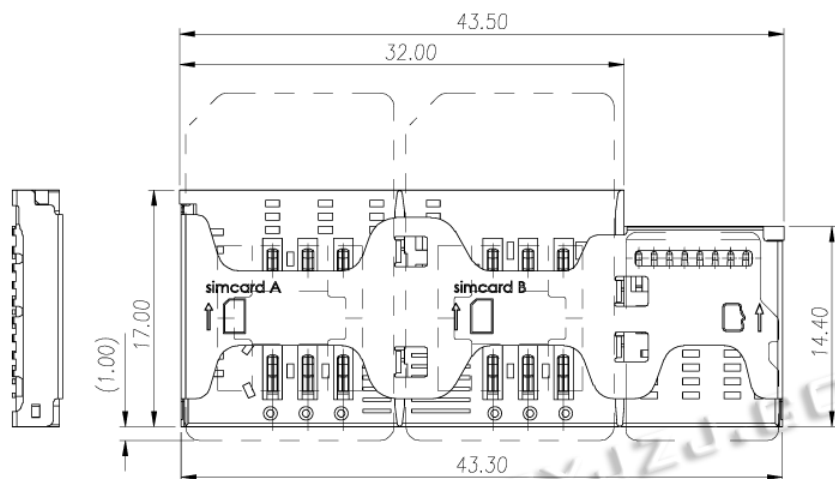


NOTES:

1) MATERIAL:

- 1-1 HOUSING:THERMOPLASTIC,UL 94V-0,COLOR:BLACK
- 1-2 CONTACT:COPPER ALLOY, T=0.15mm
- 1-3 SHELL:STAINLESS STEEL T=0.20mm

2) FINISH:

- 2-1 CONTACT:GOLD PLATING ON CONTACT AREA(SEE P/N DESCRIPTION)
100u"MIN MATTE Sn PLANTING OR 1u" MIN Au PLATING ON SOLD AREA,
50u" MIN NICKEL UNDERPLATING OVER ALL
- 2-2 SHELL:1u" MIN Au PLATING ON SOLDER AREA
50u" MIN NICKEL UNDERPLATING OVER ALL

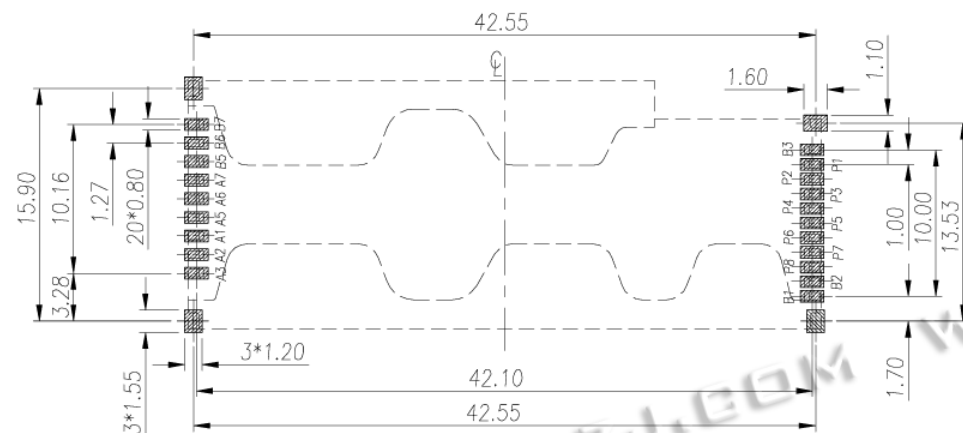
3) PRODUCT SPECIFICATIONS:

- 3-1 VOLTAGE RATING: 50V
- 3-2 CURRENT RATING: 1.0A
- 3-3 INSULATION RESISTANCE: 1000MEG.OHM MIN
- 3-4 CONTACT RESISTANCE: 50 MILL.OHM MAX
- 3-5 OPERATION TEMPERATURE: -20° TO +85°
- 3-6 DURABILITY: 3000 CYCLES

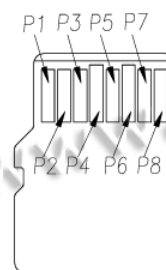
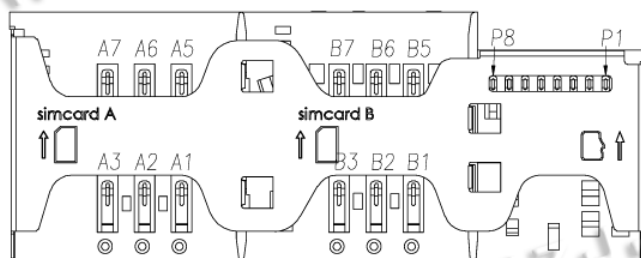


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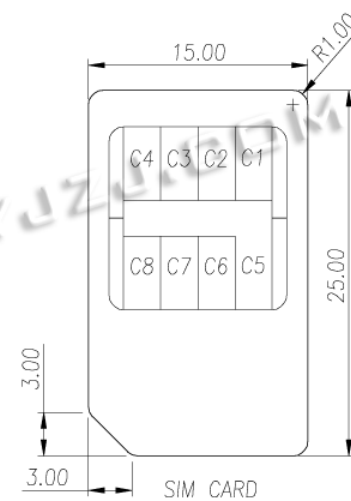
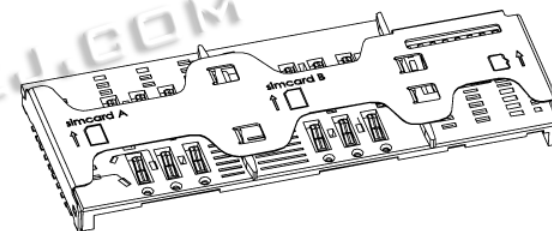
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 并排三合一卡座 (3.65H)	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HVC15-3IN120-435	MOLD NO.
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HVC-IN113565212	SHEET NO. 1 OF 2



RECOMMENDED P.C.B LAYOUT
GENERAL TOLERANCES:±0.05



Micro-SD CARD



C1:VCC
C2:RST
C3:CLK
C4:RESERVED
C5:GND
C6:VPP
C7:I/O
C8:RESERVED

Pin No.	NAME	TYPE	DESCRIPTION
1	DAT 2	I/O/PP	Date Line(bit2)
2	CD/DAT 3	I/O/PP	Card Detect/Date Line(bit3)
3	CMD	PP	Command Response
4	VDD	S	Supply Voltage
5	CLK	I	Colck
6	VSS	S	Supply Voltage Ground
7	DAT0	I/O/PP	Date Line(bit0)
8	DAT1	I/O/PP	Date Line(bit1)

DETECT PIN



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TOLERANCE:
X.X ±0.30
X.XX ±0.25
X.XXX ±0.15

X.* ±2* X.X* ±0.5*



UNIT: mm [inch]

SCALE:1:1 SIZE: A4

DRAWN BY :
陈一鸣

DATE :
2014-02-23

PART NAME:
并排三合一卡座 (3.65H)

CHECKED BY:
马跃

DATE :
2014-02-23

PART NO.
MOLD NO.

APPROVED BY:
邱国夷

DATE :
2014-02-23

DRAW NO:
SHEET NO.

HYC-IN113565212

2 OF 2